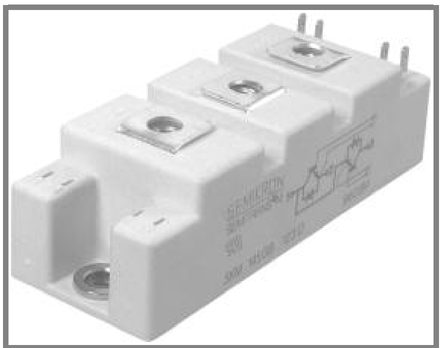
SKM 145GB176D



SEMITRANS® 2

Trench IGBT Modules

SKM 145GB176D

SKM 145GAL176D

Features

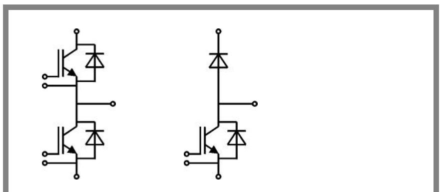
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability, self limiting to 6 x I_C

Typical Applications*

- AC inverter drives mains 575 - 750 V AC
- Public transport (auxiliary systems

Remarks

- Take care of over-voltage caused by stray inductances.
- Short circuit: Soft R_G necessary!

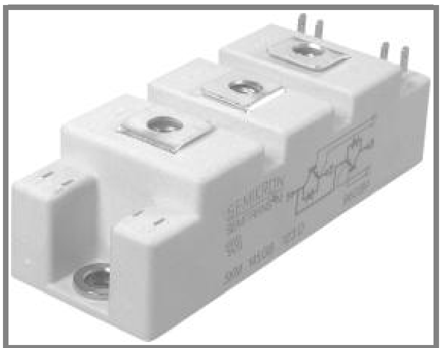


Absolute Maximum Ratings — T_{case} = 25°C, unless otherwise specified

Symbol	Conditions		Values	Units
IGBT				
V_{CES}	T_j = 25 °C		1700	V
I_C	T_j = 150 °C	T_{case} = 25 °C	160	A
		T_{case} = 80 °C	120	A
I_{CRM}	I_{CRM}=2xI_{Cnom}		200	A
V_{GES}			± 20	V
t_{psc}	V_{CC} = 1200 V; $V_{GE} \leq$ 20 V; V_{CES} < 1700 V	T_j = 125 °C	10	µs
Inverse Diode				
I_F	T_j = 150 °C	T_{case} = 25 °C	140	A
		T_{case} = 80 °C	100	A
I_{FRM}	I_{FRM}=2xI_{Fnom}		200	A
I_{FSM}	t_p = 10 ms; sin.	T_j = 150 °C	1400	A
Freewheeling Diode				
I_F	T_j = 150 °C	T_{case} = 25 °C	140	A
		T_{case} = 80 °C	100	A
I_{FRM}	I_{FRM}=2xI_{Fnom}		200	A
I_{FSM}	t_p = 10 ms; sin.	T_j = 150 °C	1400	A
Module				
$I_{t(RMS)}$			200	A
T_{vj}			- 40 ... +150	°C
T_{stg}			- 40 ... +125	°C
V_{isol}	AC, 1 min.		4000	V

Characteristics — T_{case} = 25°C, unless otherwise specified

Symbol	Conditions		min.	typ.	max.	Units
IGBT						
$V_{GE(th)}$	V_{GE} = V_{CE}, I_C = 3,5 mA		5,2	5,8	6,4	V
I_{CES}	V_{GE} = 0 V, V_{CE} = V_{CES}	T_j = 25 °C			3	mA
V_{CE0}		T_j = 25 °C		1	1,2	V
		T_j = 125 °C		0,9	1,1	V
r_{CE}	V_{GE} = 15 V	T_j = 25°C		10	12,5	mΩ
		T_j = 125°C		15		mΩ
$V_{CE(sat)}$	I_{Cnom} = 100 A, V_{GE} = 15 V	T_j = 25°$C_{chiplev.}$		2	2,45	V
		T_j = 125°$C_{chiplev.}$		2,4		V
C_{ies}	V_{CE} = 25, V_{GE} = 0 V	f = 1 MHz		7,1		nF
C_{oes}				0,37		nF
C_{res}				0,29		nF
Q_G	V_{GE} = -8V...+15V			800		nC
$t_{d(on)}$	R_{Gon} = 1 Ω	V_{CC} = 1200V		250		ns
t_r		I_C= 100A		32		ns
E_{on}		T_j = 125 °C		60		mJ
$t_{d(off)}$	R_{Goff} = 1 Ω	V_{GE} = ± 15 V		630		ns
t_f				145		ns
E_{off}				38		mJ
$R_{th(j-c)}$	per IGBT				0,19	K/W



SEMITRANS® 2

Trench IGBT Modules

SKM 145GB176D

SKM 145GAL176D

Features

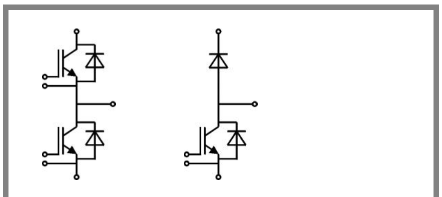
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability, self limiting to 6 x I_C

Typical Applications*

- AC inverter drives mains 575 - 750 V AC
- Public transport (auxiliary systems

Remarks

- Take care of over-voltage caused by stray inductances.
- Short circuit: Soft R_G necessary!

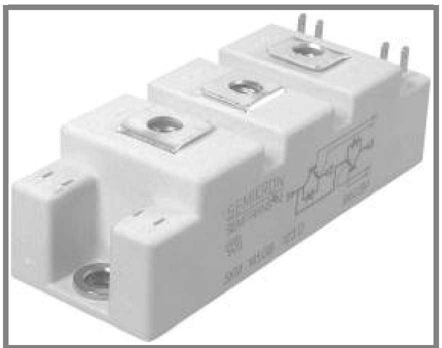


GB GAL

Characteristics						
Symbol	**Conditions**		**min.**	**typ.**	**max.**	**Units**
Inverse Diode						
$V_F = V_{EC}$	I_{Fnom} = 100 A; V_{GE} = 0 V	T_j = 25 °$C_{chiplev.}$		1,6	1,9	V
		T_j = 125 °$C_{chiplev.}$		1,6	1,9	V
V_{F0}		T_j = 25 °C		1,1	1,3	V
		T_j = 125 °C		0,9	1,1	V
r_F		T_j = 25 °C		5	6	mΩ
		T_j = 125 °C		7	8	mΩ
I_{RRM}	I_F = 100 A	T_j = 125 °C		77		A
Q_{rr}	di/dt = 2450 A/µs			39,5		µC
E_{rr}	V_{GE} = -15 V; V_{CC} = 1200 V			27,5		mJ
$R_{th(j-c)D}$	per diode				0,36	K/W
Freewheeling Diode						
$V_F = V_{EC}$	I_{Fnom} = 100 A; V_{GE} = 0 V	T_j = 25 °$C_{chiplev.}$		1,6	1,9	V
		T_j = 125 °$C_{chiplev.}$		1,6	1,9	V
V_{F0}		T_j = 25 °C		1,1	1,3	V
		T_j = 125 °C		0,9	1,1	V
r_F		T_j = 25 °C		5	6	V
		T_j = 125 °C		7	8	V
I_{RRM}	I_F = 100 A	T_j = 125 °C		77		A
Q_{rr}	di/dt = 2450 A/µs			39,5		µC
E_{rr}	V_{GE} = -15 V; V_{CC} = 1200 V			27,5		mJ
$R_{th(j-c)FD}$	per diode				0,36	K/W
Module						
L_{CE}					30	nH
$R_{CC'+EE'}$	res., terminal-chip	T_{case}= 25 °C		0,75		mΩ
		T_{case}= 125 °C		1		mΩ
$R_{th(c-s)}$	per module				0,05	K/W
M_s	to heat sink M6		3		5	Nm
M_t	to terminals M5		2,5		5	Nm
w					160	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.



SEMITRANS® 2

Trench IGBT Modules

SKM 145GB176D

SKM 145GAL176D

Features

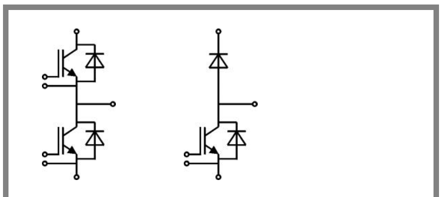
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability, self limiting to 6 x I_C

Typical Applications*

- AC inverter drives mains 575 - 750 V AC
- Public transport (auxiliary systems

Remarks

- Take care of over-voltage caused by stray inductances.
- Short circuit: Soft R_G necessary!



GB GAL

Z_{th} Symbol	Conditions	Values	Units
$Z_{th(j-c)I}$			
R_i	i = 1	115	mk/W
R_i	i = 2	38,5	mk/W
R_i	i = 3	5,7	mk/W
R_i	i = 4	0,8	mk/W
tau_i	i = 1	0,0306	s
tau_i	i = 2	0,0852	s
tau_i	i = 3	0,004	s
tau_i	i = 4	0,0003	s
$Z_{th(j-c)D}$			
R_i	i = 1	190	mk/W
R_i	i = 2	80	mk/W
R_i	i = 3	25	mk/W
R_i	i = 4	5	mk/W
tau_i	i = 1	0,0475	s
tau_i	i = 2	0,0163	s
tau_i	i = 3	0,0011	s
tau_i	i = 4	0,0002	s

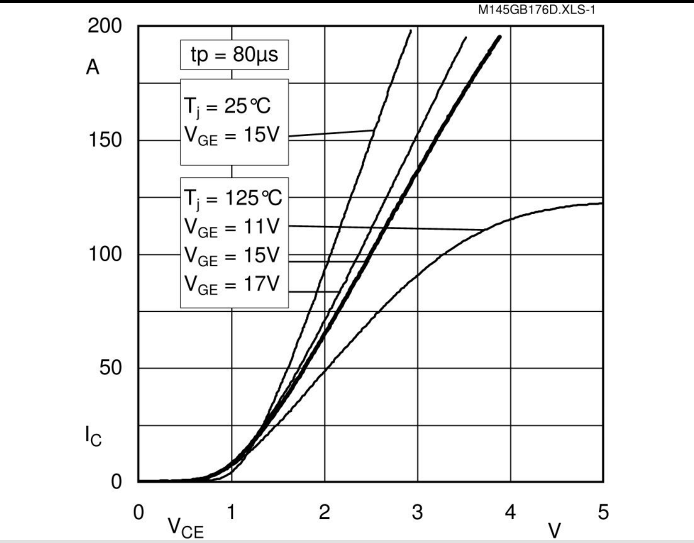


Fig. 1 Typ. output characteristic, inclusive $R_{CC'+ EE'}$

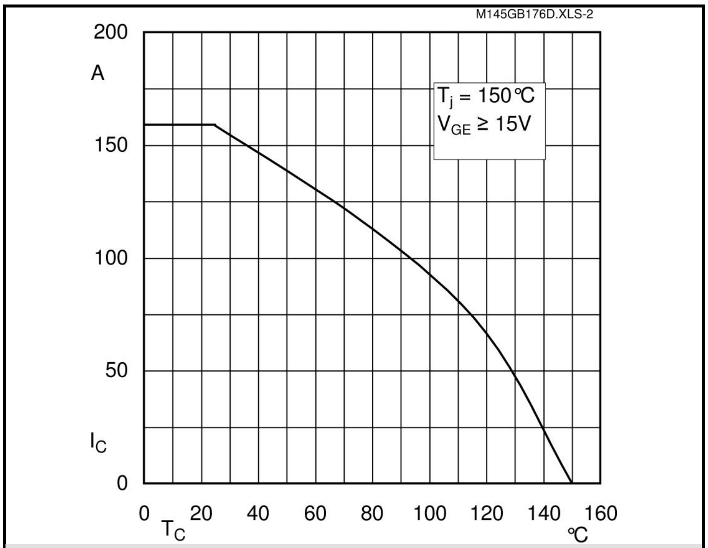


Fig. 2 Rated current vs. temperature I_C = f (T_C)

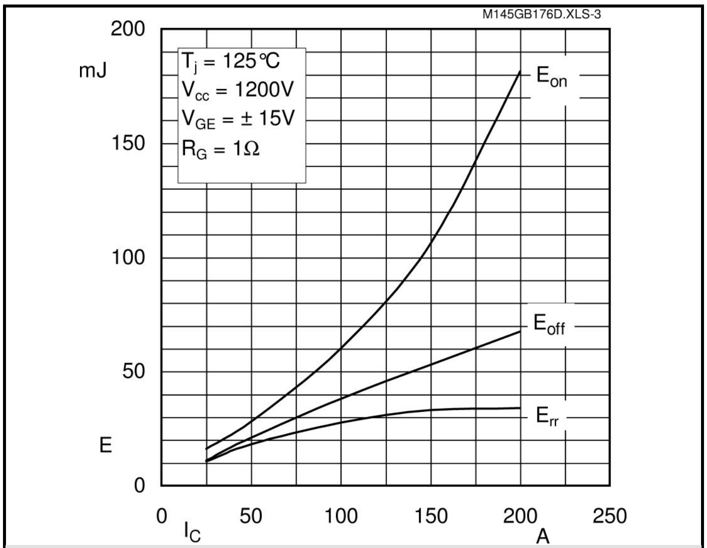


Fig. 3 Typ. turn-on /-off energy = f (I_C)

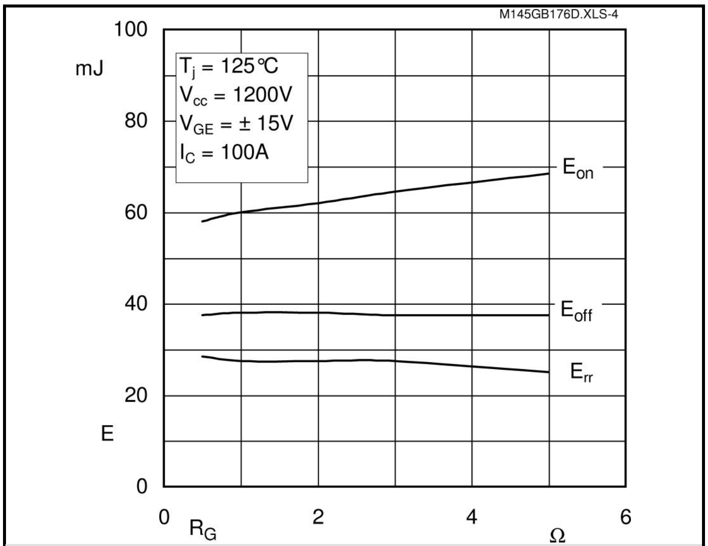


Fig. 4 Typ. turn-on /-off energy = f (R_G)

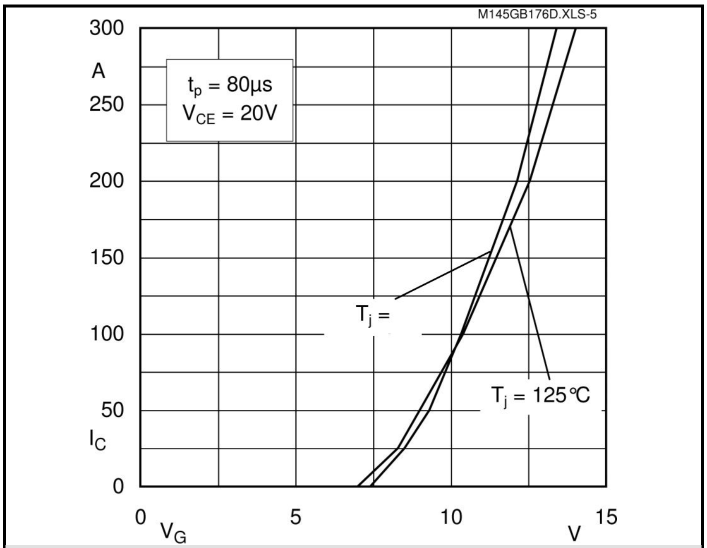


Fig. 5 Typ. transfer characteristic

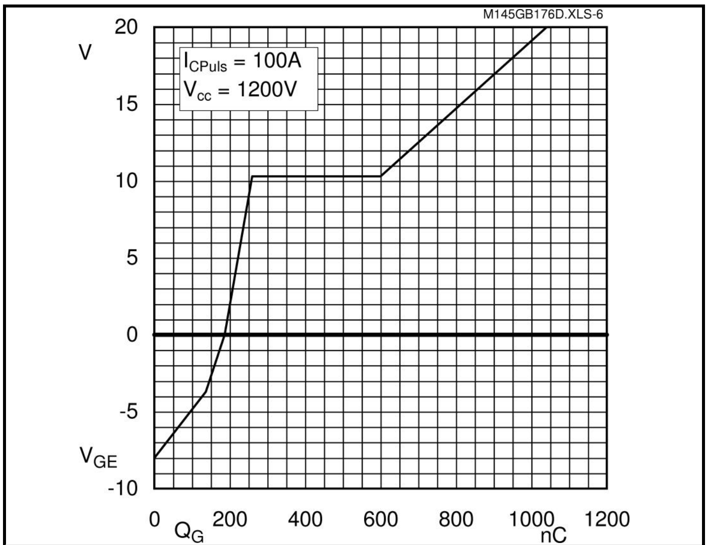


Fig. 6 Typ. gate charge characteristic

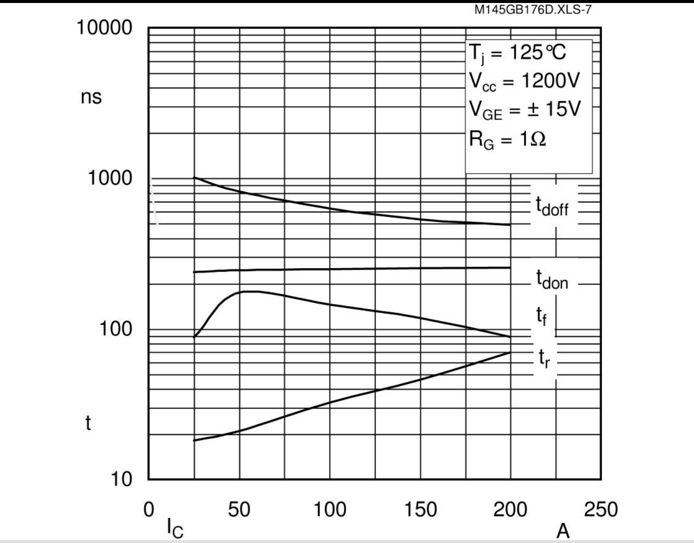


Fig. 7 Typ. switching times vs. I_C

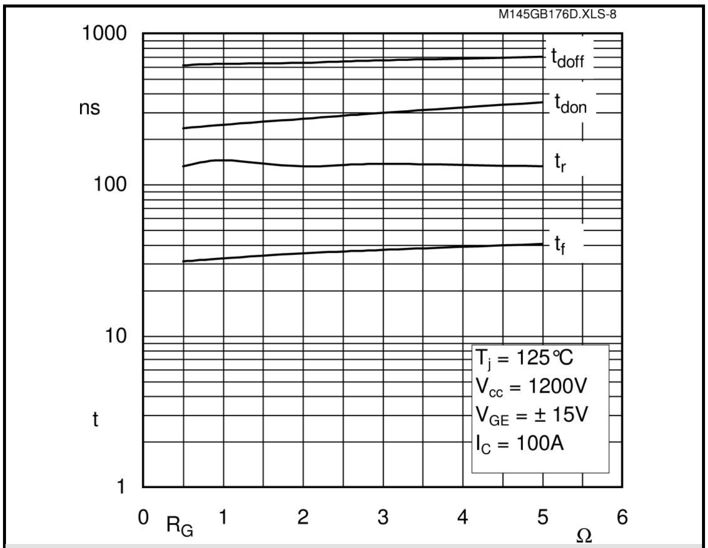


Fig. 8 Typ. switching times vs. gate resistor R_G

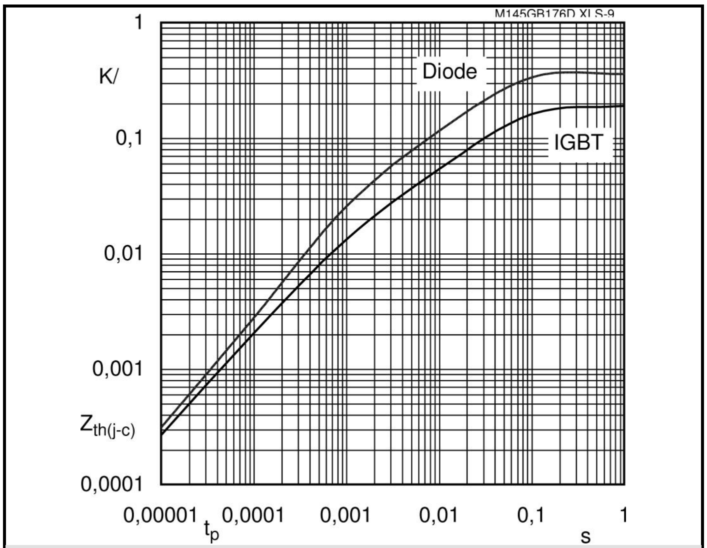


Fig. 9 Transient thermal impedance of IGBT and Diode

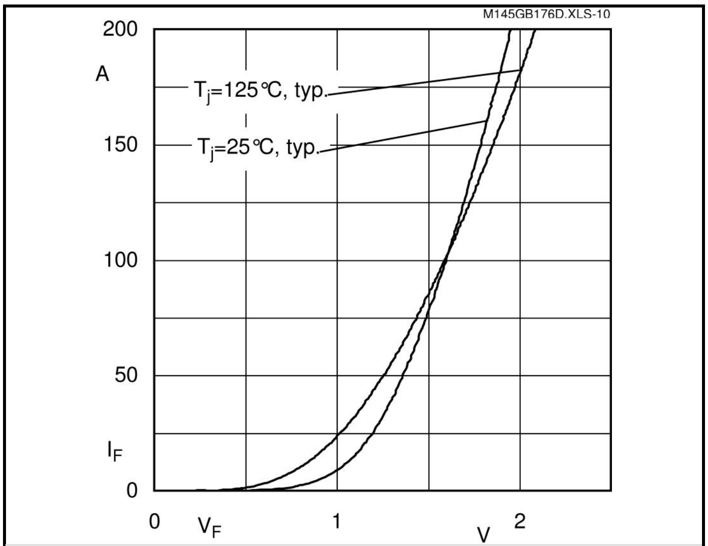


Fig. 10 CAL diode forward characteristic

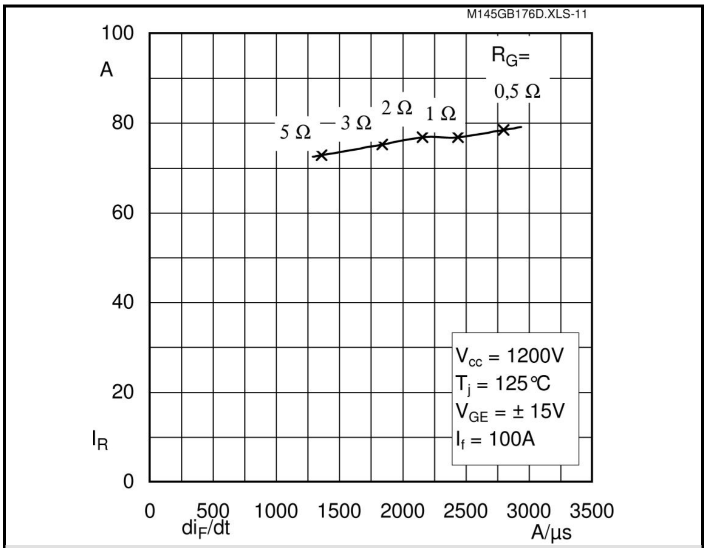


Fig. 11 Typ. CAL diode peak reverse recovery current

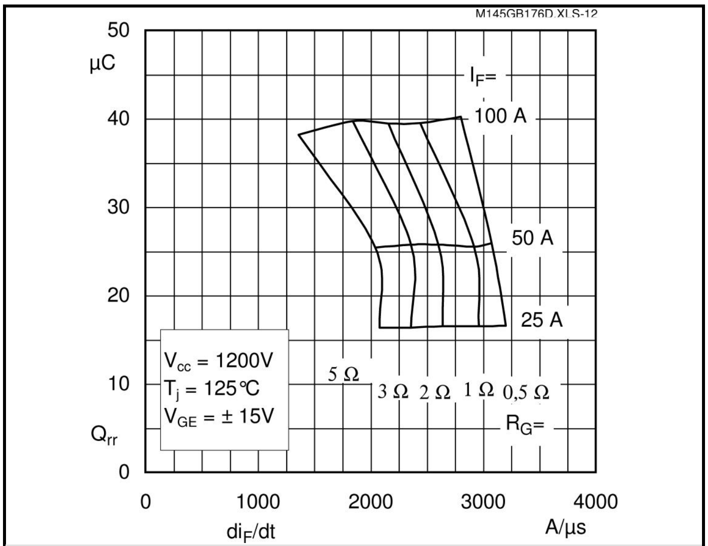
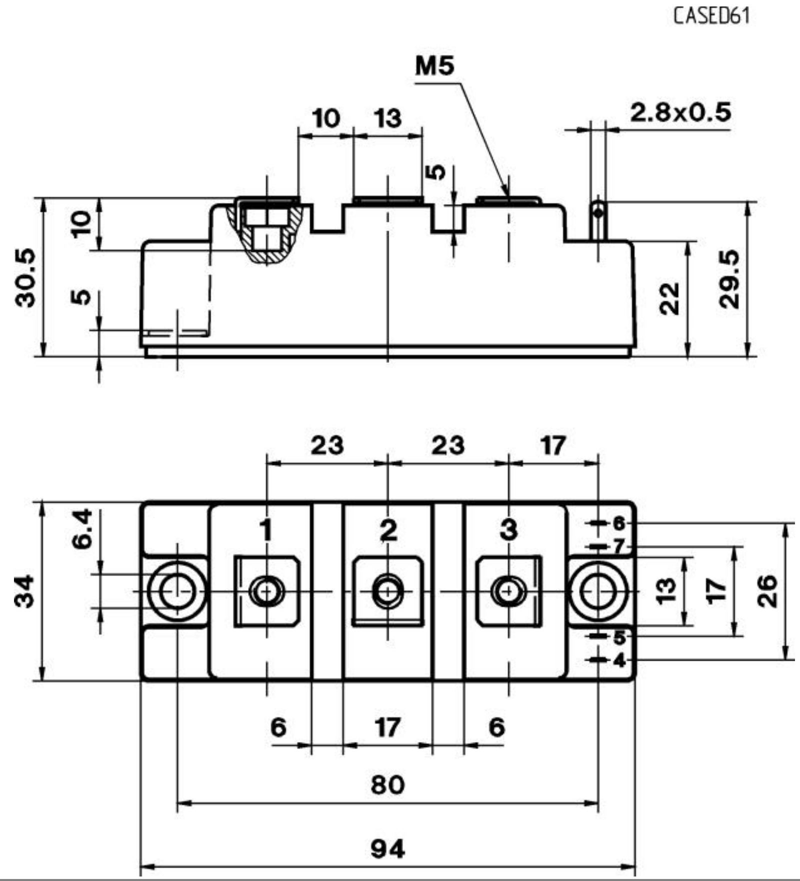


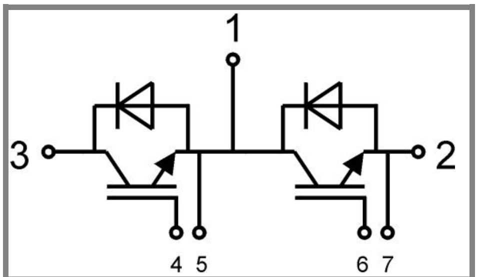
Fig. 12 Typ. CAL diode recovered charge

UL Recognized

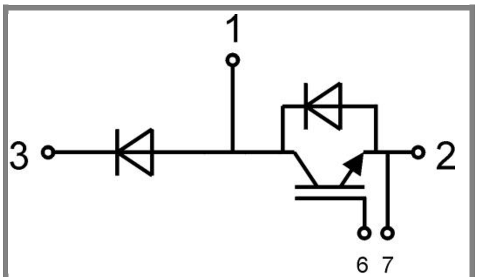
File no. E 63 532



Case D 61



GB Case D 61



GAL Case D 62

